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MICRO-FUSE AND ITS MANUFACTURING METHOD

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- international:

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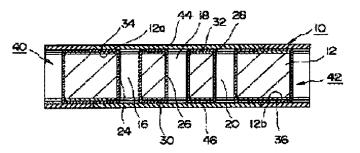
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Abstract of **JP2002042632**

PROBLEM TO BE SOLVED: To provide a microfuse with high pulse resistance characteristics. SOLUTION: Fuse layers 24, 26, 28 are formed on the inner surfaces on plural holes 16, 18, 20 installed so as to pass through from the surface 12a to the surface 12b of an insulator 12, and these fuse layers 24, 26, 28 are connected with connecting conductors 30, 32, 36. At least one of shapes, diameters, and distances between the holes of the holes 16, 18, 20 is varied to obtain the desirable fusing characteristics.



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